

# DATA SHEET

**RAA216**

I2C remote control LCD display

## D.C. Characteristics

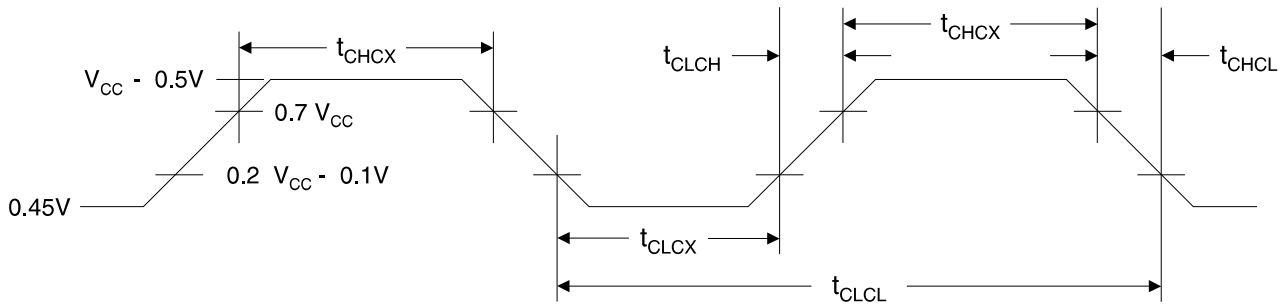
$T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$ ,  $V_{CC} = 2.7\text{ V}$  to  $6.0\text{ V}$  (unless otherwise noted)

Symbol	Parameter	Condition	Min	Max	Units
$V_{IL}$	Input Low Voltage		-0.5	$0.2 V_{CC} - 0.1$	V
$V_{IH}$	Input High Voltage	(Except XTAL1, RST)	$0.2 V_{CC} + 0.9$	$V_{CC} + 0.5$	V
$V_{IH1}$	Input High Voltage	(XTAL1, RST)	$0.7 V_{CC}$	$V_{CC} + 0.5$	V
$V_{OL}$	Output Low Voltage <sup>(1)</sup> (Ports 1, 3)	$I_{OL} = 20\text{ mA}$ , $V_{CC} = 5\text{ V}$ $I_{OL} = 10\text{ mA}$ , $V_{CC} = 2.7\text{ V}$		0.5	V
$V_{OH}$	Output High Voltage (Ports 1, 3)	$I_{OH} = -80\ \mu\text{A}$ , $V_{CC} = 5\text{ V} \pm 10\%$	2.4		V
		$I_{OH} = -30\ \mu\text{A}$	$0.75 V_{CC}$		V
		$I_{OH} = -12\ \mu\text{A}$	$0.9 V_{CC}$		V
$I_{IL}$	Logical 0 Input Current (Ports 1, 2, 3)	$V_{IN} = 0.45\text{ V}$		-50	$\mu\text{A}$
$I_{TL}$	Logical 1 to 0 Transition Current (Ports 1, 2, 3)	$V_{IN} = 2\text{ V}$		-750	$\mu\text{A}$
$I_{LI}$	Input Leakage Current (Port P1.0, P1.1)	$0 < V_{IN} < V_{CC}$		$\pm 10$	$\mu\text{A}$
$V_{OS}$	Comparator Input Offset Voltage	$V_{CC} = 5\text{ V}$		20	mV
$V_{CM}$	Comparator Input Common Mode Voltage		0	$V_{CC}$	V
RRST	Reset Pulldown Resistor		50	300	$\text{K}\Omega$
$C_{IO}$	Pin Capacitance	Test Freq. = 1 MHz, $T_A = 25^\circ\text{C}$		10	pF
$I_{CC}$	Power Supply Current	Active Mode, 12 MHz, $V_{CC} = 6\text{ V}/3\text{ V}$		15/5.5	mA
		Idle Mode, 12 MHz, $V_{CC} = 6\text{ V}/3\text{ V}$ P1.0 & P1.1 = 0V or $V_{CC}$		5/1	mA
	Power Down Mode <sup>(2)</sup>	$V_{CC} = 6\text{ V}$ P1.0 & P1.1 = 0V or $V_{CC}$		100	$\mu\text{A}$
		$V_{CC} = 3\text{ V}$ P1.0 & P1.1 = 0V or $V_{CC}$		20	$\mu\text{A}$

Notes: 1. Under steady state (non-transient) conditions,  $I_{OL}$  must be externally limited as follows:  
Maximum  $I_{OL}$  per port pin: 20 mA  
Maximum total  $I_{OL}$  for all output pins: 80 mA

If  $I_{OL}$  exceeds the test condition,  $V_{OL}$  may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.  
2. Minimum  $V_{CC}$  for Power Down is 2 V.

## External Clock Drive Waveforms



## External Clock Drive

Symbol	Parameter	$V_{CC} = 2.7 V \text{ to } 6.0 V$		$V_{CC} = 4.0 V \text{ to } 6.0 V$		Units
		Min	Max	Min	Max	
$1/t_{CLCL}$	Oscillator Frequency	0	12	0	24	MHz
$t_{CLCL}$	Clock Period	83.3		41.6		ns
$t_{CHCX}$	High Time	30		15		ns
$t_{CLCX}$	Low Time	30		15		ns
$t_{CLCH}$	Rise Time		20		20	ns
$t_{CHCL}$	Fall Time		20		20	ns

Figure 1. Oscillator Connections

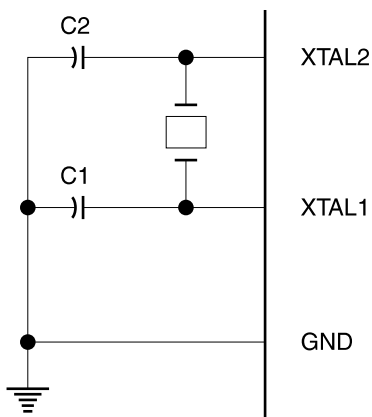
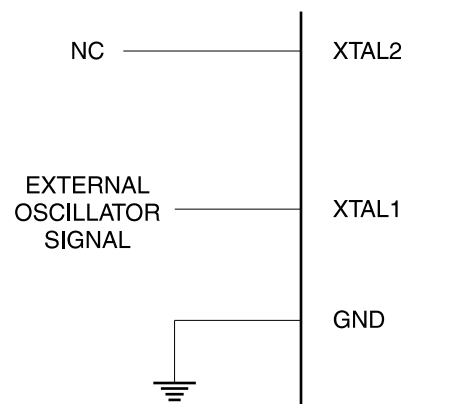


Figure 2. External Clock Drive Configuration

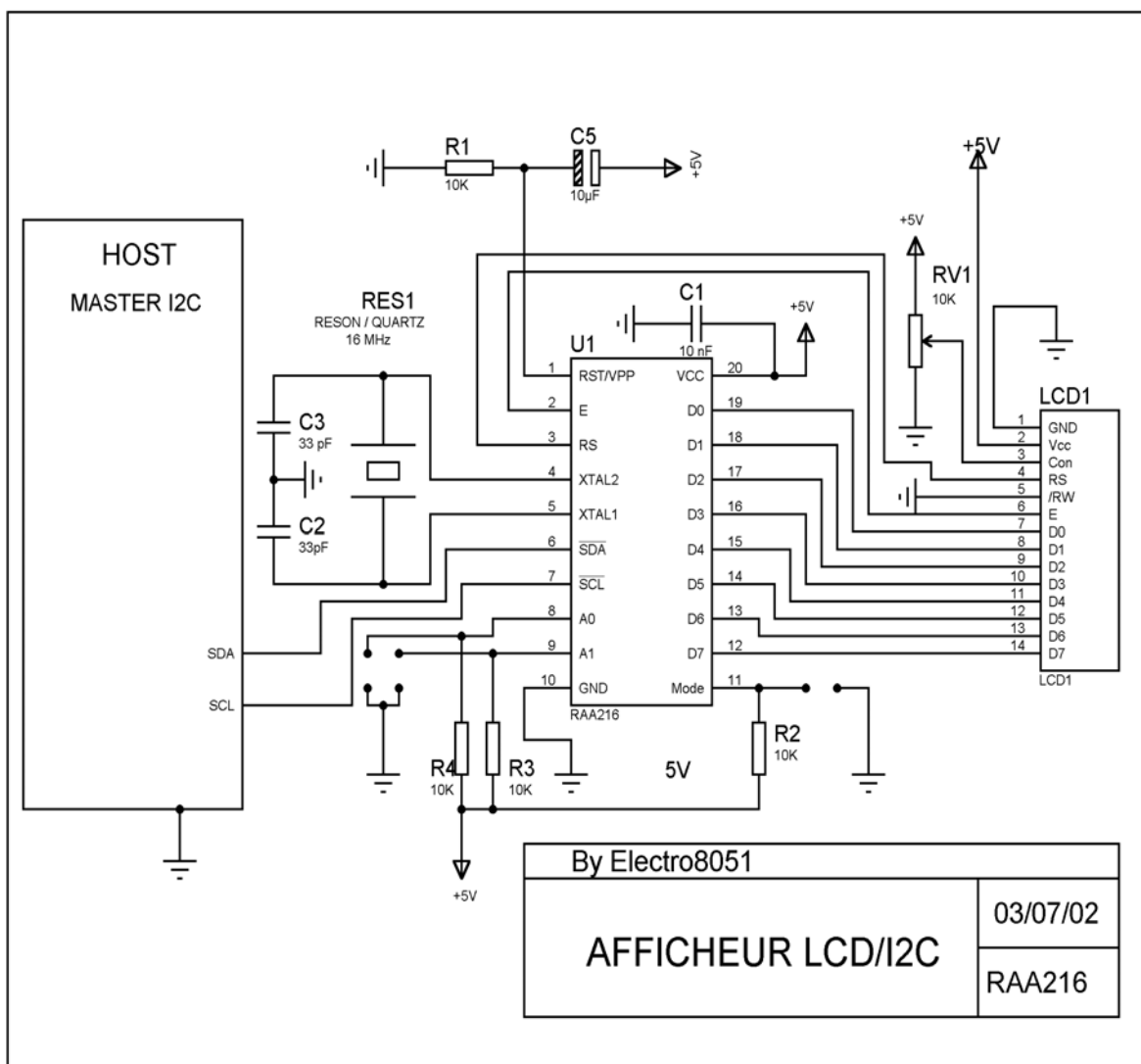


Notes: C1, C2 = 30 pF  $\pm$  10 pF for Crystals  
 = 40 pF  $\pm$  10 pF for Ceramic Resonators

*RAA216 DIP 20 package*

Pin	Name	Type	Active	Use
1	RST	Input	High	Reset
2	E	Output	High	Enable LCD
3	RS	Output		Low:instruction,high:data
4	Xtal2	Input		To crystal
5	Xtal1	Input		To crystal
6	SDA	Input/Output	Low	SDATA I2C
7	SCL	Output		SCLOCK I2C
8	A0	Input	Must be tired to 0V or 5V	Adress select A0
9	A1	Input	Must be tired to 0V or 5V	Adress select A1
10	GND	Power		
11	Mode	Input	Must be tired to 0V or 5V	Mode=0:1L,Mode=1:2Lines
12	D7	Output	High open colector	Data to LCD
13	D6	Output	High open colector	Data to LCD
14	D5	Output	High	Data to LCD
15	D4	Output	High	Data to LCD
16	D3	Output	High	Data to LCD
17	D2	Output	High	Data to LCD
18	D1	Output	High	Data to LCD
19	D0	Output	High	Data to LCD
20	VCC	Power		

## *Schematic application*

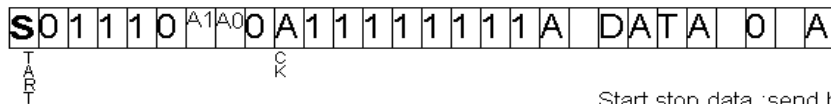


## *WRITE I2C*

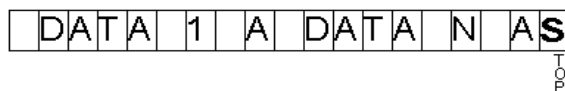
### **WRITE DATA**

20 data bytes + 00 max

Slave adress                      FF:DATA



N<21



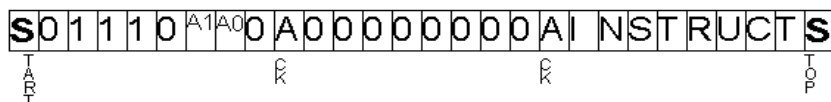
Start, stop, data : send by master

Ack : send by RAA216

Synchro : send by master

### **WRITE INSTRUCTION**

Slave adress                      00:INSTRUCTION



See table : List of instructions

## *List of instructions*

Instruction	Code	Execution time writing I2C
Clear display	0 0 0 0 0 0 1	1.52ms *
Return home	0 0 0 0 0 1 -	1.52ms *
Entry set Mode	0 0 0 0 1 I/D S	0
Display Control	0 0 0 1 D C B	0
Cursor or display shift	0 0 1 S/C R/L - -	0
Function set	0 0 1 DL N F - -	0
Set CGRAM address	0 1 A A A A A A	0
Set DDRAM address	1 A A A A A A A	0
Jump 2° line	1 1 0 0 0 0 0	0

\* When writing I2C Clear display or Return home, it's necessary waiting 1.52ms before writing another instruction or data in I2C to LCD display

I/D =1 : Increment  
 I/D =0 ; Decreemnt  
 S =1 ; Accompanies display shift  
 S/C =1 ; Display shift  
 S/C =0 ; Cursor move  
 R/L =1 ; Shift to the right  
 R/L =0 ; Shift to the left  
 DL =1 ; 8 bits,DL =0 : 4 bits  
 N =1 ; 2 lines,N = 0 : 1 line  
 F =1 ; 5\*10 dots,F = 0 : 5\*8 dots

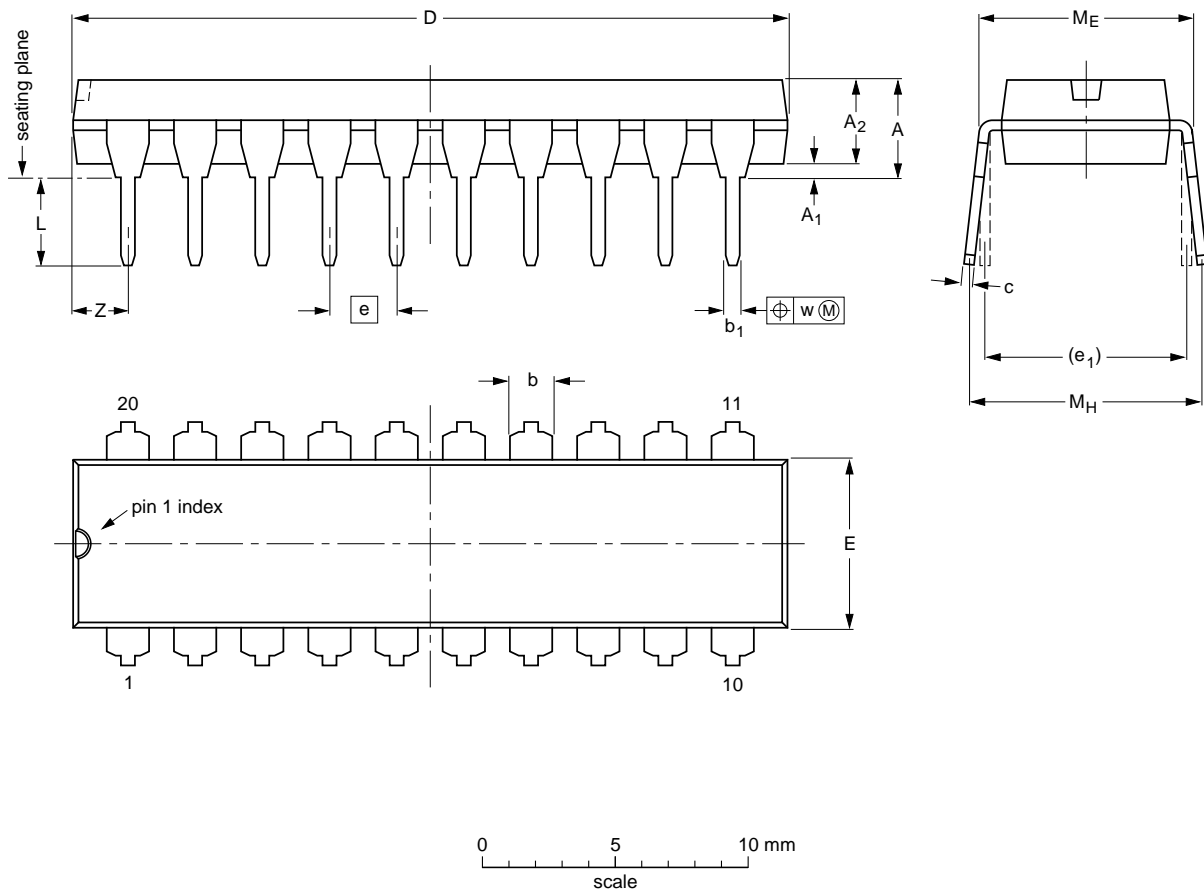
# I2C remote control LCD Display

RAA216

## PACKAGE OUTLINES

DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



**DIMENSIONS** (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

**Note**

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT146-1			SC603			